TOSHIBA Field Effect Transistor Silicon P Channel MOS Type

SSM6P15FU

High Speed Switching Applications Analog Switch Applications

Small package

• Low ON resistance : $R_{on} = 12 \Omega \text{ (max) } (@V_{GS} = -4 \text{ V})$

: $R_{on} = 32 \Omega \text{ (max) } (@V_{GS} = -2.5 \text{ V})$

Absolute Maximum Ratings (Ta = 25°C) (Q1, Q2 Common)

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		V_{DS}	-30	V	
Gate-Source voltage		V _{GSS}	±20	V	
Drain current	DC	ID	-100	mA	
	Pulse	I _{DP}	-200		
Drain power dissipation (Ta = 25°C)		P _D (Note 1)	200	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the

absolute maximum ratings.

Please design the appropriate reliability upon reviewing the

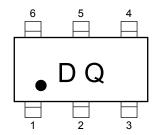
Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Total rating.

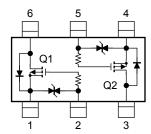
1: Source1 2: Gate1 3: Drain2 4: Source2 US6 5: Gate2 6: Drain1 JEDEC — JEITA — TOSHIBA 2-2J1C

Weight: 0.0068g(typ.)

Marking



Equivalent Circuit (top view)



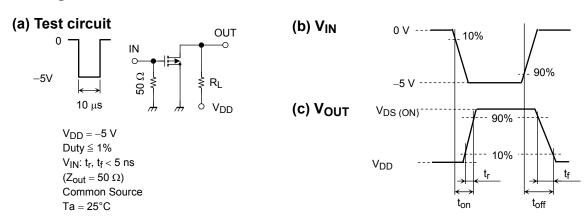
Handling Precaution

When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Electrical Characteristics (Ta = 25°C) (Q1, Q2 common)

Characteristic		Symbol	Test Condition	MIN.	TYP.	MAX.	UNIT	
Gate leakage current		I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$	_	_	±1	μА	
Drain-Source breakdown voltage		V (BR) DSS	$I_D = -0.1 \text{ mA}, V_{GS} = 0$	-30	_	_	V	
Drain cut-off current		I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0$	_	_	-1	μА	
Gate threshold voltage		V_{th}	$V_{DS} = -3 \text{ V}, I_D = -0.1 \text{ mA}$	-1.1	_	-1.7	V	
Forward transfer admittance		Y _{fs}	$V_{DS} = -3 \text{ V}, I_D = -10 \text{ mA}$	20	_	_	mS	
Drain-Source ON resistance		R _{DS} (ON)	$I_D = -10 \text{ mA}, V_{GS} = -4 \text{ V}$	_	8	12	Ω	
			$I_D = -1 \text{ mA}, V_{GS} = -2.5 \text{ V}$	_	14	32		
Input capacitance		C _{iss}	V _{DS} = -3 V, V _{GS} = 0, f = 1 MHz	_	9.1	_	pF	
Reverse transfer capacitance		C _{rss}		_	3.5	_	pF	
Output capacitance		Coss		_	8.6	_	pF	
Switching time	Turn-on time	t _{on}	$V_{DD} = -5 \text{ V}, I_D = -10 \text{ mA},$	_	65	_	ns	
	Turn-off time	t _{off}	V _{GS} = 0~-5 V	_	175	_		

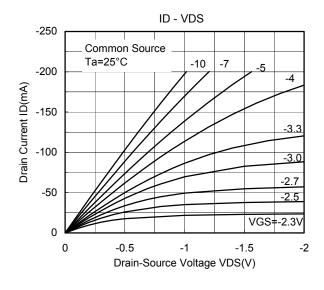
Switching Time Test Circuit

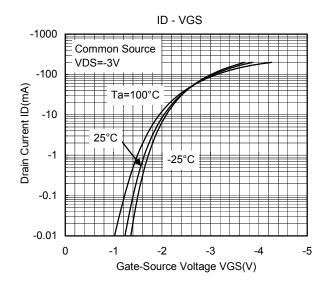


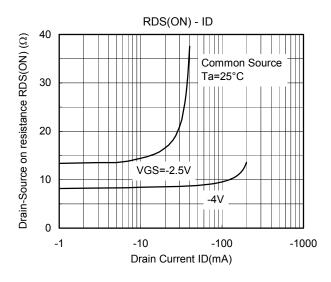
Precaution

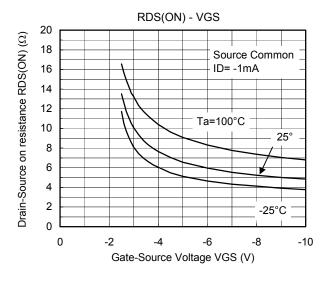
 V_{th} can be expressed as voltage between gate and source when low operating current value is $I_D=-100~\mu A$ for this product. For normal switching operation, $V_{GS~(on)}$ requires higher voltage than V_{th} and $V_{GS~(off)}$ requires lower voltage than V_{th} . (Relationship can be established as follows: $V_{GS~(off)} < V_{th} < V_{GS~(on)}$)

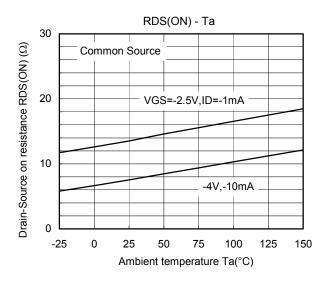
Please take this into consideration for using the device.

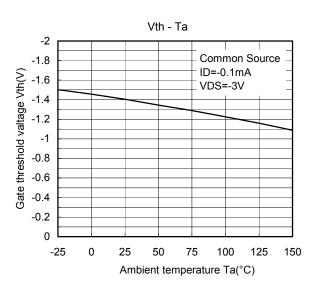




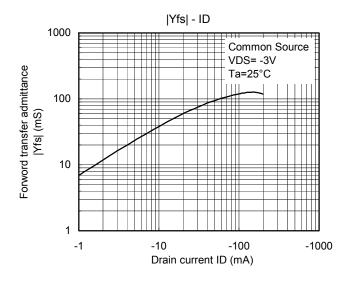


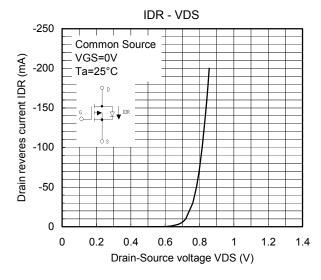


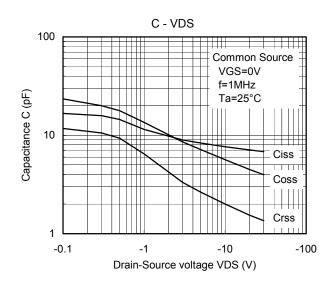


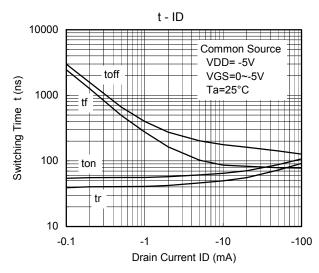


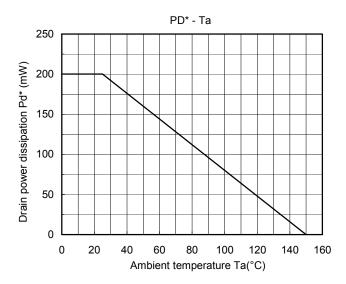
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*: Total Rating

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20070701-EN GENERAL

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